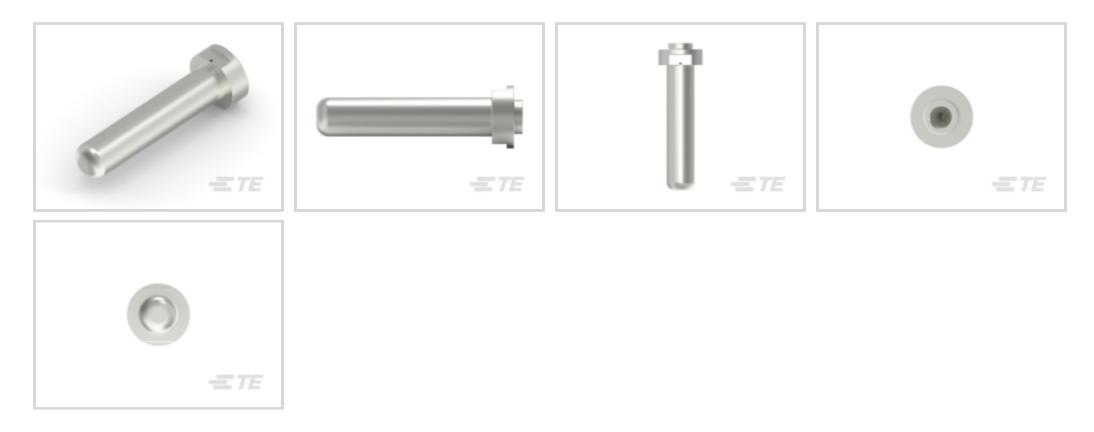


ICCON

TE Internal #: 2361493-1 Busbar Connectors, Board-to-Board, 1 Position, Printed Circuit Board, Mating Alignment, Bag & Box, Vertical, Vertical, Copper Alloy, Normal, ICCON

View on TE.com >

Connectors > Power Connectors > Power Busbar Connectors > Busbar Connectors



Connector System: **Board-to-Board** Number of Positions: **1**

Connector & Contact Terminates To: Printed Circuit Board

Mating Alignment: With

PCB Mount Retention Type: Solder Pad

Features



Product Type Features

Connector & Housing Type	Plug
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	1
PCB Mount Orientation	Vertical
Mating & Unmating Configuration	Normal
Electrical Characteristics	
Operating Voltage	48 VAC
Body Features	
Bus Bar Contact Plating Material	Silver
Contact Features	
Contact Underplating Material Thickness	1.27 μm[50 μin]

Busbar Connectors, Board-to-Board, 1 Position, Printed Circuit Board, Mating Alignment, Bag & Box, Vertical, Vertical, Copper Alloy, Normal, ICCON



Contact Mating Area Plating Material Thickness	3 μm[120 μin]
Contact Shape & Form	Multiple Contact Band/CROWN BAND
Contact Underplating Material	Nickel
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	200 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Screw
Mechanical Attachment	
Mating Alignment Type	Blindmate
Mating Alignment	With
PCB Mount Retention Type	Solder Pad
Bus Bar Mount Orientation	Vertical
Dimensions	
Connector Height	42.1 mm[1.657 in]
PCB Thickness (Recommended)	1.5 – 2 mm[.06 – .079 in]
Product Length	12 mm[.394 in]
Usage Conditions	

Operating Temperature Range	-40 – 105 °C
Operation/Application	
Circuit Application	Power
Industry Standards	
Agency/Standard	UL
Packaging Features	
Packaging Method	Bag & Box
Product Compliance For compliance documentation, visit the product page on TE.com>	
·	Compliant
For compliance documentation, visit the product page on TE.com>	Compliant Compliant
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	

Busbar Connectors, Board-to-Board, 1 Position, Printed Circuit Board, Mating Alignment, Bag & Box, Vertical, Vertical, Copper Alloy, Normal, ICCON



Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC Low Halogen - Br, Cl, F, I < 900 ppm per

homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Halogen Content

Not reviewed for solder process capability

Product Compliance Disclaimer

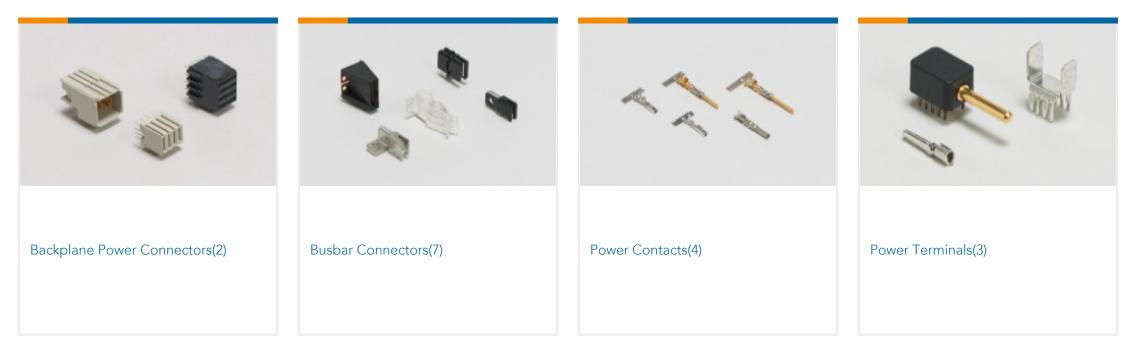
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts





Also in the Series ICCON



Busbar Connectors, Board-to-Board, 1 Position, Printed Circuit Board, Mating Alignment, Bag & Box, Vertical, Vertical, Copper Alloy, Normal, ICCON





Customers Also Bought



TE Part #DT06-2S

TE Part #0460-202-16141

TE Part #114017-ZZ

Documents

Product Drawings ICCON INSERT SIZE 8.0mm PIN

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2361493-1_2.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2361493-1_2.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2361493-1_2.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

S For support call+1 800 522 6752

Busbar Connectors, Board-to-Board, 1 Position, Printed Circuit Board, Mating Alignment, Bag & Box, Vertical, Vertical, Copper Alloy, Normal, ICCON



Product Specifications Product Specification

English

Product Environmental Compliance Product Compliance

English

Product Compliance

English